Electronic Supplementary Information

Solution-processed Cu@Au nanowires for transparent conductive films and electromagnetic shielding

Xinyu Wang[a], Juan Xu[*ab], Ying Li[a], Yuhao Zhang[a], Xin Wu[a] and Caixia Kan[*ab]

[a] *College of Physics, Nanjing University of Aeronautics and Astronautics, Nanjing 211106, China. E-mail: xujuan@nuaa.edu.cn; cxkan@nuaa.edu.cn*

[b] *MIIT Key Laboratory of Aerospace Information Materials and Physics, Nanjing University of Aeronautics and Astronautics, Nanjing 211106, China.*

Supplementary figures

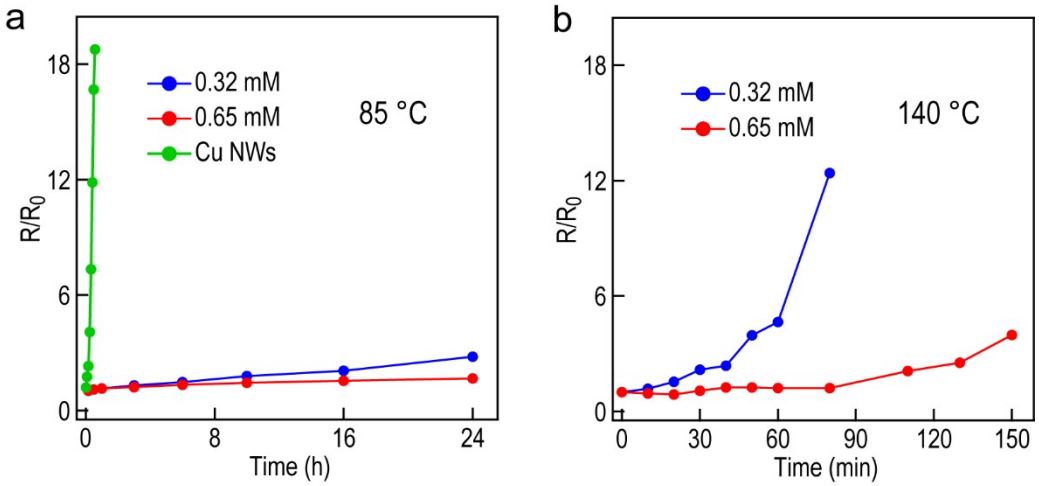

Figure S1 Thermal stability of transparent conductive films (TCFs) based on Cu nanowires (NWs) treated with different concentrations of Au precursor solution (a) at 85 °C and (b) at 140 °C in ambient air.

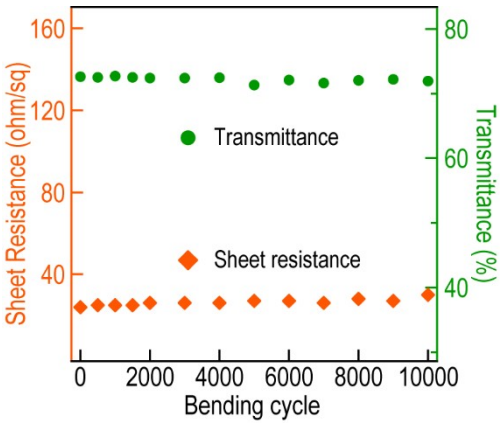

Figure S2 Sheet resistance and optical transmittance for the Cu@Au NW/PLLA film after 10000 bending cycles under 180% strain.